

APPROVAL SHEET

WW04P

±1%, ±5%

Low ohm power chip resistors Size 0402(1005)

^{*}Contents in this sheet are subject to change without prior notice.



FEATURE

- 1. High power rating and compact size
- 2. High reliability and stability
- 3. Reduced size of final equipment
- 4. Lead free product is upon customer requested.
- 5. Current sensing resistor

APPLICATION

- PDA
- Cable Modem
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

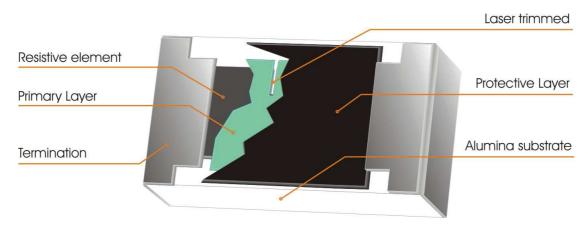


Fig 1. Consctruction of Chip-R



QUICK REFERENCE DATA

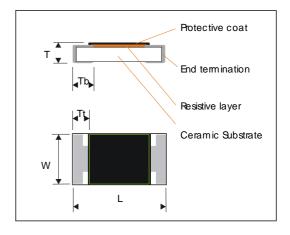
Item	General Specification
Series No.	WW04P
Size code	0402 (1005)
Resistance Tolerance	±1%, ±5%
Resistance Range	0.1Ω ~ 0.91Ω
TCR (ppm/°C)	
0.47 ~ 0.976 ohm	0 ~ +200 ppm/°C
0.1 ~ 0.43 ohm	0 ~ +300 ppm/°C
Max. dissipation at T _{amb} =70°C	1/8 W
Max. Operation current (DC or RMS)	1.11 amper
Climatic category (IEC 60068)	55/125/56

Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by $RCWV = \sqrt{RatedPower \times Resistance Value} \quad \text{or Max. RCWV listed above, whichever is lower.}$
- 3. Lead free product is upon customer requested.

MECHANICAL DATA

Unit : mm	WW04P	
L	1.00 ± 0.05	
W	0.50 ± 0.05	
Т	0.35 ± 0.05	
Tt	0.20 ± 0.10	
Tb	0.25 +0.05/- 0.10	



MARKING

WW04P series has no marking on the product overcoat for both 5% & 1%.



FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of \pm 5% & \pm 1%. The values of the E24/E96 series are in accordance with "IEC publication 60063".

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

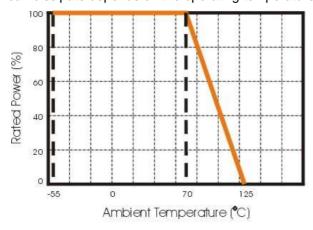


Figure 2. Maximum dissipation in percentage of rated power

As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

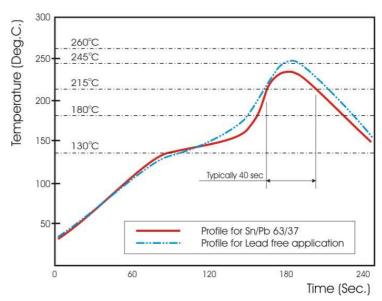


Fig 3. Infrared soldering profile



CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WW04	Р	R100	J	T	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
WW04 : 0402	P: 1/8 W	E96 + E24:	J : ±5%	T:7" Reel taping	L = Sn base (lead
		R is first digit followed by 3 significant digits.	F:±1%		free)
		$0.100\Omega = R100$			
		$0.510\Omega = R510$			

■ Reeled tape packaging : 8mm width paper taping 1000pcs per reel.

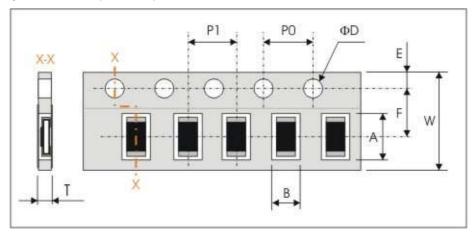
TEST AND REQUIREMENTS

TEST	PROCEDURE	REQUIREMENT
Temperature Coefficient of Resistance (TCR)	Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\!\!\times\!10^6 \; \text{(ppm/°C)}$	Test temperature −55 ~ +125°C Refer to quick reference
	R_1 : Resistance at reference temperature R_2 : Resistance at test temperature t_1 : 25°C	
Short time overload (STOL)	Permanent resistance change after a 2second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	ΔR/R max. ±1%
Resistance to	Unmounted chips 5±1 seconds, 260±5°C	no visible damage
soldering heat		Δ R/R max. ±1%
Solderability	Unmounted chip completely immersed in a lead free solder	good tinning (>95% covered)
	bath, 235°C±5°C, 2±1 sec	no visible damage
Temperature	1. 30 minutes at -55°C±3°C,	no visible damage
cycling	2. 2~3 minutes at room temperature,	ΔR/R max. ±1%
	3. 30 minutes at +125°±3°C,	
	4. 2~3 minutes at room temperature,	
	Total 5 continuous cycles	
Load life (endurance)	70±2°C, 1000 hours, loaded with RCWV or Vmax,1.5 hours on and 0.5 hours off	Δ R/R max. ±5%
Damp heat	40°C±2°C and 90~95% relative humidity,	ΔR/R max. ±5%
steady state	without current applied, 1000hours	
Bending and Adhesion	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending: 3 mm, once for 10 seconds	ΔR/R max. ±1%
	Pressurizing force 5N, test time 10±1sec	



PACKAGING

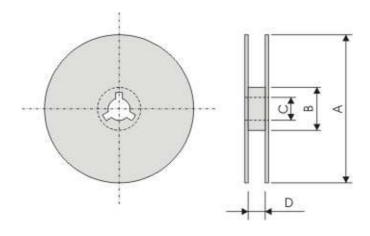
Paper Tape specifications (unit :mm)



Series No.	А	В	W	F	Е
WW04P	1.15+0.05/-0.10	0.65+0.05/-0.10	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD	Т
WW04P	2.00±0.05	4.00±0.10	Ф1.50 ^{+0.1} _{-0.0}	Max. 0.50

Reel dimensions



Symbol	Α	В	С	D
(unit : mm)	Φ180 +0/-1.5	Φ60.0±1.0	13 +1.0/-0	9 +1.0/-0